

## 74VHC08 • 74VHCT08 Quad 2-Input AND Gate

### General Description

The 74VHC/VHCT08 is an advanced high speed CMOS 2 Input AND Gate fabricated with silicon gate CMOS technology. It achieves the high-speed operation similar to equivalent Bipolar Schottky TTL while maintaining the CMOS low power dissipation.

The internal circuit is composed of 4 stages including buffer output, which provide high noise immunity and stable output. An input protection circuit insures that 0V to 7V can be applied to the input pins without regard to the supply voltage. This device can be used to interface 5V to 3V systems and two supply systems such as battery backup. This circuit prevents device destruction due to mismatched supply and input voltages.

### Features

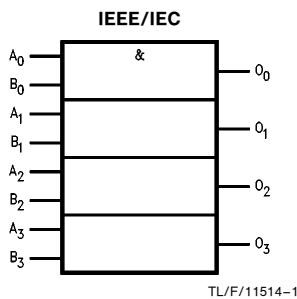
- High noise immunity:  
VHC  $V_{NIH} = V_{NIL} = 28\% V_{CC}$  (min)  
VHCT  $V_{IH} = 2.0V$ ,  $V_{IL} = 0.8V$
- Power down protection:  
VHC inputs only  
VHCT inputs and outputs
- Low noise:  $V_{OLP} = 0.8V$  (max)
- Low power dissipation:  
 $I_{CC} = 2 \mu A$  (Max) @  $T_A = 25^\circ C$
- Balanced propagation delays:  $t_{PLH} \cong t_{PHL}$
- Pin and function compatible with 74HC/HCT08

**NOTE:** Add external pull up resistor to VHCT outputs to drive CMOS inputs

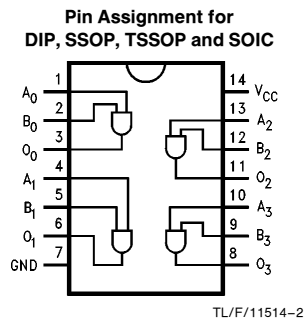
Commercial	Package Number	Package Description
74VHC08M	M14A	14-Lead Molded JEDEC SOIC
74VHC08SJ	M14D	14-Lead Molded EIAJ SOIC
74VHC08MSC	MSC14	14-Lead Molded EIAJ Type 1 SSOP
74VHC08MTC	MTC14	14-Lead Molded JEDEC Type 1 TSSOP
74VHC08N	N14A	14-Lead Molded DIP
74VHCT08M	M14A	14-Lead Molded JEDEC SOIC
74VHCT08SJ	M14D	14-Lead Molded EIAJ SOIC
74VHCT08MTC	MTC14	14-Lead Molded JEDEC Type 1 TSSOP
74VHCT08N	N14A	14-Lead Molded DIP

**Note:** Surface mount packages are also available on Tape and Reel. Specify by appending the suffix letter "X" to the ordering code. EIAJ Type 1 SSOP available on a Tape and Reel only, order MSCX.

### Logic Symbol



### Connection Diagram



Pin Names	Description
$A_n, B_n$	Inputs
$O_n$	Outputs

### Truth Table

A	B	O
L	L	L
L	H	L
H	L	L
H	H	H

## Absolute Maximum Ratings (Note 1)

Supply Voltage (V <sub>CC</sub> )	-0.5V to +7.0V
DC Input Voltage (V <sub>IN</sub> )	-0.5V to +7.0V
DC Output Voltage (V <sub>OUT</sub> )	
VHC	-0.5V to V <sub>CC</sub> + 0.5V
VHCT*	-0.5V to 7.0V
Input Diode Current (I <sub>IK</sub> )	-20 mA
Output Diode Current (I <sub>OK</sub> )	
VHC	±20 mA
VHCT	-20 mA
DC Output Current (I <sub>OUT</sub> )	±25 mA
DC V <sub>CC</sub> /GND Current (I <sub>CC</sub> )	±50 mA
Storage Temperature (T <sub>STG</sub> )	-65°C to +150°C
Lead Temperature (T <sub>L</sub> ) (Soldering, 10 seconds)	260°C

\*V<sub>OUT</sub> > V<sub>CC</sub> only if output is in H state.

Note 1: Absolute Maximum Ratings are values beyond which the device may be damaged or have its useful life impaired. The databook specifications should be met, without exception, to ensure that the system design is reliable over its power supply, temperature, and output/input loading variables. National does not recommend operation outside databook specifications.

## Recommended Operating Conditions

Supply Voltage (V <sub>CC</sub> )	
VHC	2.0V to +5.5V
VHCT	4.5V to 5.5V
Input Voltage (V <sub>IN</sub> )	0V to +5.5V
Output Voltage (V <sub>OUT</sub> )	0V to V <sub>CC</sub>
Operating Temperature (T <sub>OPR</sub> )	-40°C to +85°C
Input Rise and Fall Time (t <sub>r</sub> , t <sub>f</sub> )	
V <sub>CC</sub> = 3.3V ±0.3V (VHC only)	0 ns/V ~ 100 ns/V
V <sub>CC</sub> = 5.0V ±0.5V	0 ns/V ~ 20 ns/V

## DC Characteristics for 'VHC Family Devices

Symbol	Parameter	V <sub>CC</sub> (V)	74VHC			74VHC		Units	Conditions		
			T <sub>A</sub> = 25°C			T <sub>A</sub> = -40°C to +85°C					
			Min	Typ	Max	Min	Max				
V <sub>IH</sub>	High Level Input Voltage	2.0 3.0-5.5	1.50			1.50		V			
V <sub>IL</sub>	Low Level Input Voltage	2.0 3.0-5.5			0.50 0.3 V <sub>CC</sub>	0.50		V			
V <sub>OH</sub>	High Level Output Voltage	2.0	1.9	2.0		1.9		V	V <sub>IN</sub> = V <sub>IH</sub> or V <sub>IL</sub>	I <sub>OH</sub> = -50 μA	
		3.0	2.9	3.0		2.9					
V <sub>OL</sub>	Low Level Output Voltage	4.5	4.4	4.5		4.4		V		I <sub>OH</sub> = -4 mA I <sub>OH</sub> = -8 mA	
		3.0	2.58			2.48					
V <sub>OL</sub>	Low Level Output Voltage	4.5	3.94			3.80		V			
		3.0		0.0	0.1		0.1		V	V <sub>IN</sub> = V <sub>IH</sub> or V <sub>IL</sub>	I <sub>OL</sub> = 50 μA
V <sub>OL</sub>	Low Level Output Voltage	4.5			0.36		0.44		V		I <sub>OL</sub> = 4 mA I <sub>OL</sub> = 8 mA
		3.0			0.36		0.44				
I <sub>IN</sub>	Input Leakage Current	0-5.5			±0.1		±1.0	μA	V <sub>IN</sub> = 5.5V or GND		
I <sub>CC</sub>	Quiescent Supply Current	5.5			2.0		20.0	μA	V <sub>IN</sub> = V <sub>CC</sub> or GND		

### DC Characteristics for 'VHC Family Devices

Symbol	Parameter	V <sub>CC</sub> (V)	74VHC		Units	Conditions
			T <sub>A</sub> = 25°C			
			Typ	Limits		
**V <sub>OLP</sub>	Quiet Output Maximum Dynamic V <sub>OL</sub>	5.0	0.3	0.8	V	C <sub>L</sub> = 50 pF
**V <sub>OLV</sub>	Quiet Output Minimum Dynamic V <sub>OL</sub>	5.0	-0.3	-0.8	V	C <sub>L</sub> = 50 pF
**V <sub>IHD</sub>	Minimum High Level Dynamic Input Voltage	5.0		3.5	V	C <sub>L</sub> = 50 pF
**V <sub>ILD</sub>	Maximum Low Level Dynamic Input Voltage	5.0		1.5	V	C <sub>L</sub> = 50 pF

\*\*Parameter guaranteed by design.

### DC Characteristics for 'VHCT Family Devices

Symbol	Parameter	V <sub>CC</sub> (V)	74VHCT			74VHCT		Units	Conditions
			T <sub>A</sub> = 25°C			T <sub>A</sub> = -40°C to +85°C			
			Min	Typ	Max	Min	Max		
V <sub>IH</sub>	High Level Input Voltage	4.5 5.5	2.0 2.0			2.0 2.0	V		
V <sub>IL</sub>	Low Level Input Voltage	4.5 5.5			0.8 0.8	0.8 0.8	V		
V <sub>OH</sub>	High Level Output Voltage	4.5	3.15	3.65		3.15	V	V <sub>IN</sub> = V <sub>IH</sub>   I <sub>OH</sub> = -50 μA	
		4.5	2.5			2.4	V	I <sub>OH</sub> = -8 mA	
V <sub>OL</sub>	Low Level Output Voltage	4.5		0.0	0.1	0.1	V	V <sub>IN</sub> = V <sub>IH</sub>   I <sub>OL</sub> = 50 μA	
		4.5			0.36	0.44	V	I <sub>OL</sub> = 8 mA	
I <sub>IN</sub>	Input Leakage Current	0-5.5			±0.1	±1.0	μA	V <sub>IN</sub> = 5.5V or GND	
I <sub>CC</sub>	Quiescent Supply Current	5.5			2.0	20.0	μA	V <sub>IN</sub> = V <sub>CC</sub> or GND	
I <sub>CCT</sub>	Maximum I <sub>CC</sub> / Input	5.5			1.35	1.50	mA	V <sub>IN</sub> = 3.4V Other Inputs = V <sub>CC</sub> or GND	
I <sub>OPD</sub>	Output Leakage Current (Power Down State)	0.0			0.5	5.0	μA	V <sub>OUT</sub> = 5.5V	

## DC Characteristics for 'VHCT Family Devices

Symbol	Parameter	V <sub>CC</sub> (V)	74VHCT		Units	Conditions
			T <sub>A</sub> = 25°C			
			Typ	Limit		
*V <sub>OLP</sub>	Quiet Output Maximum Dynamic V <sub>OL</sub>		0.4	0.8	V	C <sub>L</sub> = 50 pF
*V <sub>OLV</sub>	Quiet Output Minimum Dynamic V <sub>OL</sub>		-0.4	-0.8	V	C <sub>L</sub> = 50 pF
*V <sub>IHD</sub>	Minimum High Level Dynamic Input Voltage			2.0	V	C <sub>L</sub> = 50 pF
*V <sub>ILD</sub>	Maximum Low Level Dynamic Input Voltage			0.8	V	C <sub>L</sub> = 50 pF

\*Parameter guaranteed by design.

## AC Electrical Characteristics for 'VHC Family Devices

Symbol	Parameter	V <sub>CC</sub> (V)	74VHC			74VHC		Units	Conditions
			T <sub>A</sub> = 25°C			T <sub>A</sub> = -40°C to +85°C			
			Min	Typ	Max	Min	Max		
t <sub>PHL</sub> , t <sub>PLH</sub>	Propagation Delay	3.3 ± 0.3	6.2	8.8	1.0	10.5	ns	C <sub>L</sub> = 15 pF	
			8.7	12.3	1.0	14.0		C <sub>L</sub> = 50 pF	
		5.0 ± 0.5	4.3	5.9	1.0	7.0	ns	C <sub>L</sub> = 15 pF	
			5.8	7.9	1.0	9.0		C <sub>L</sub> = 50 pF	
C <sub>IN</sub>	Input Capacitance		4	10	10		pF	V <sub>CC</sub> = Open	
C <sub>PD</sub>	Power Dissipation Capacitance		18				pF	(Note 1)	

**Note 1:** C<sub>PD</sub> is defined as the value of the internal equivalent capacitance which is calculated from the operating current consumption without load. Average operating current can be obtained by the equation: I<sub>CC (opr.)</sub> = C<sub>PD</sub> \* V<sub>CC</sub> \* f<sub>IN</sub> + I<sub>CC</sub>/4 (per gate).

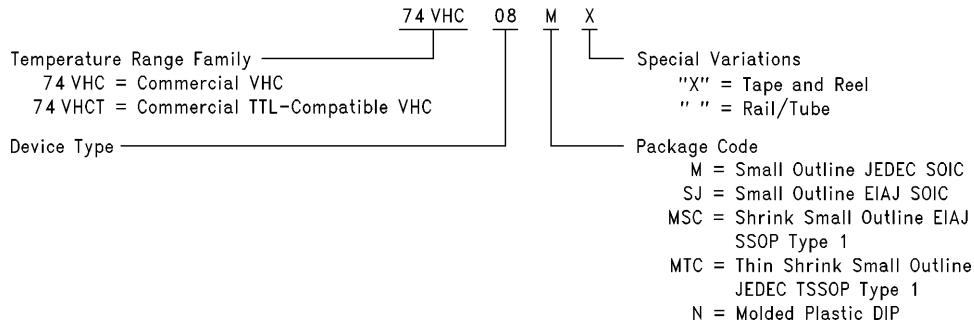
## AC Electrical Characteristics for 'VHCT Family Devices

Symbol	Parameter	V <sub>CC</sub> (V)	74VHCT			74VHCT		Units	Conditions
			T <sub>A</sub> = 25°C			T <sub>A</sub> = -40°C to +85°C			
			Min	Typ	Max	Min	Max		
t <sub>PLH</sub> , t <sub>PHL</sub>	Propagation Delay	5.0 ± 0.5	5.0	6.9	1.0	8.0	ns	C <sub>L</sub> = 15 pF	
			5.5	7.9	1.0	9.0		C <sub>L</sub> = 50 pF	
C <sub>IN</sub>	Input Capacitance		4	10	10		pF	V <sub>CC</sub> = Open	
C <sub>PD</sub>	Power Dissipation Capacitance		18				pF	(Note 1)	

**Note 1:** C<sub>PD</sub> is defined as the value of the internal equivalent capacitance, which is calculated from the operating current consumption without load. Average operating current can be obtained from the equation: I<sub>CC (opr.)</sub> = C<sub>PD</sub> \* V<sub>CC</sub> \* f<sub>IN</sub> + I<sub>CC</sub>/4 (per gate)

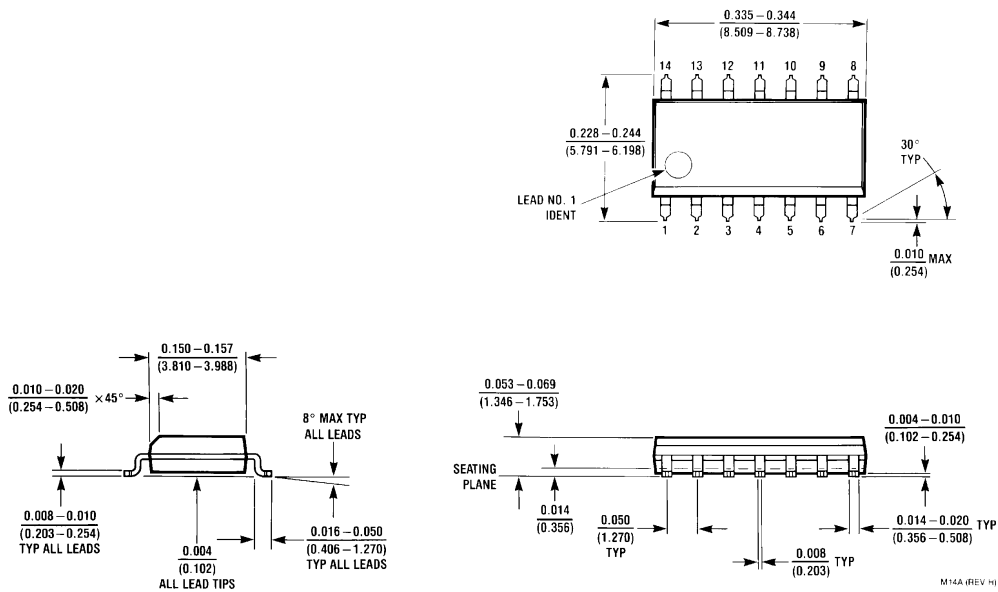
## Ordering Information

The device number is used to form part of a simplified purchasing code, where the package type and temperature range are defined as follows:



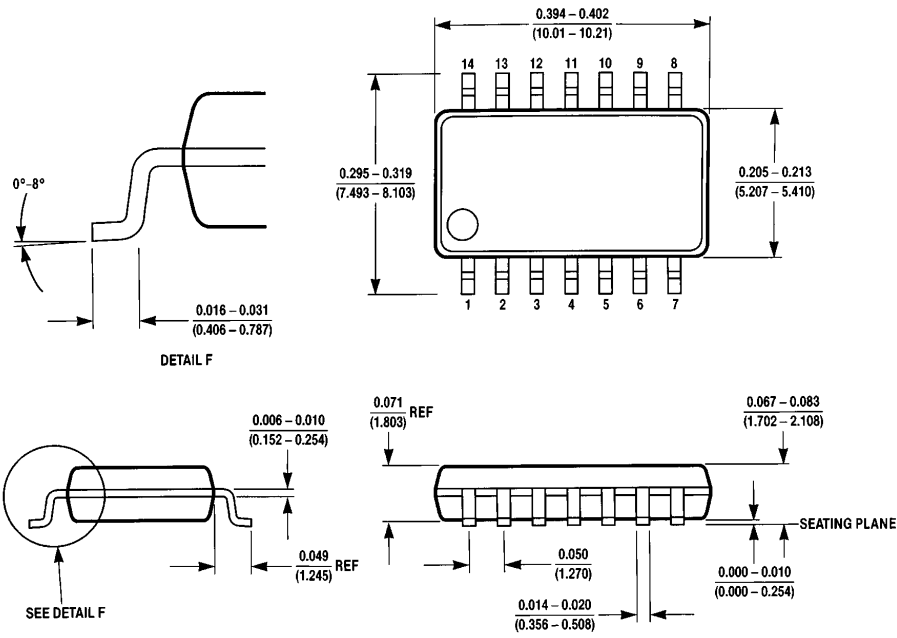
TL/F/11514-3

## Physical Dimensions inches (millimeters)



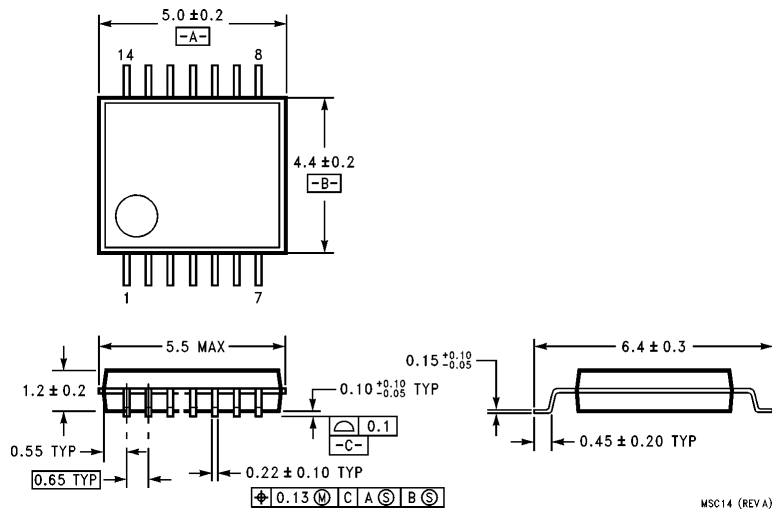
**14-Lead Small Outline Integrated Circuit—JEDEC SOIC (M)**  
**Order Number 74VHC08M, 74VHC08MX, 74VHCT08M or 74VHCT08MX**  
**NS Package Number M14A**

**Physical Dimensions** inches (millimeters) (Continued)



M14D (REV A)

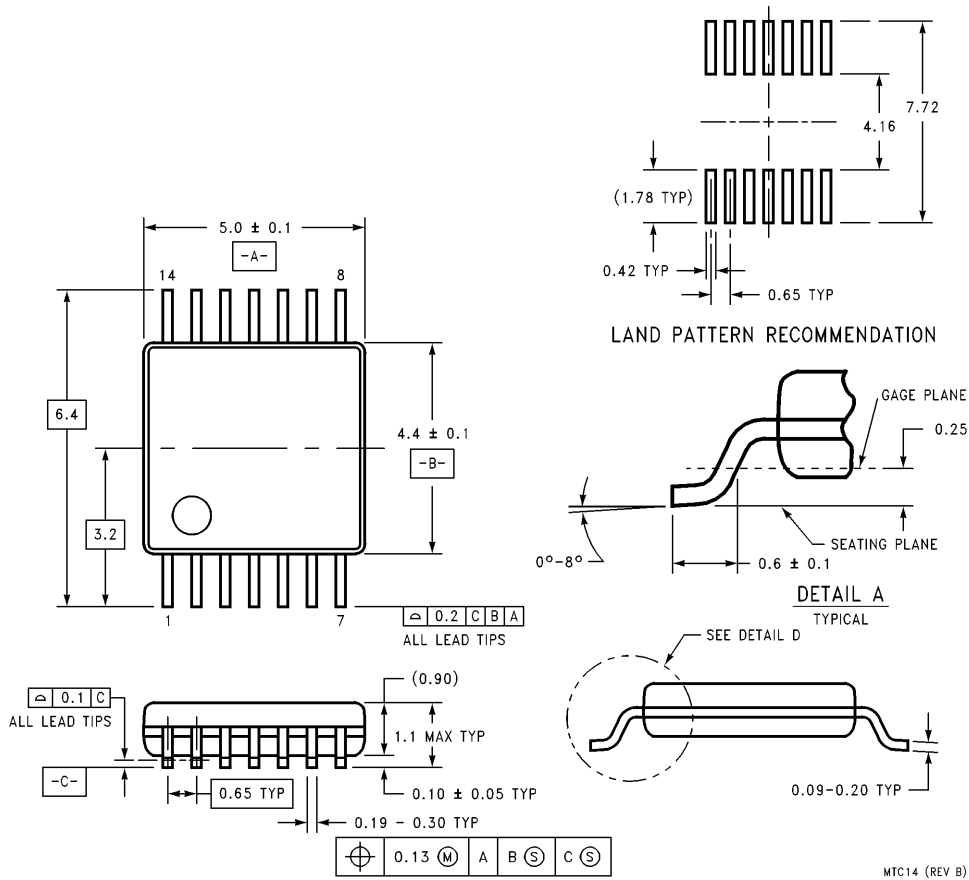
**14-Lead Plastic EIAJ SOIC (SJ)**  
**Order Number 74VHC08SJ, 74VHC08SJX, 74VHCT08SJ, or 74VHCT08SJX**  
**NS Package Number M14D**



MSC14 (REV A)

**14-Lead Plastic EIAJ SSOP Type I (MSC)**  
**Order Number 74VHC08MSCX**  
**NS Package Number MSC14**

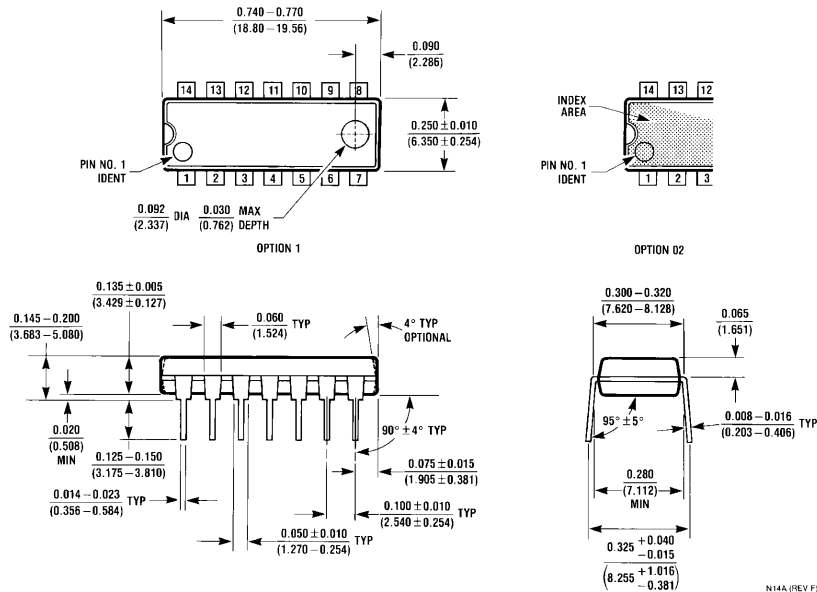
**Physical Dimensions** inches (millimeters) (Continued)



**14-Lead Plastic JEDEC TSSOP Type I (MTC)**  
**Order Number 74VHC08MTC, 74VHC08MTCX, 74VHCT08MTC, or 74VHCT08MTCX**  
**NS Package Number MTC14**

MTC14 (REV B)

**Physical Dimensions** inches (millimeters) (Continued)



**14-Lead Molded Dual-In-Line Package (MDIP)**  
**Order Number 74VHC08N or 74VHCT08N**  
**NS Package Number N14A**

N14A (REV F)

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